


Cite this: *Nanoscale*, 2020, **12**, 22234

Understanding metal organic chemical vapour deposition of monolayer WS₂: the enhancing role of Au substrate for simple organosulfur precursors†

Ye Fan,^{‡a} Kenichi Nakanishi,^{‡a} Vlad P. Veigang-Radulescu,^a Ryo Mizuta,^a J. Callum Stewart,^a Jack E. N. Swallow,^b Alice E. Dearle,^{id a} Oliver J. Burton,^a Jack A. Alexander-Webber,^{id a} Pilar Ferrer,^c Georg Held,^c Barry Brennan,^d Andrew J. Pollard,^d Robert S. Weatherup,^{id b} and Stephan Hofmann^{id *a}

We find that the use of Au substrate allows fast, self-limited WS₂ monolayer growth using a simple sequential exposure pattern of low cost, low toxicity precursors, namely tungsten hexacarbonyl and dimethylsulfide (DMS). We use this model reaction system to fingerprint the technologically important metal organic chemical vapour deposition process by *operando* X-ray photoelectron spectroscopy (XPS) to address the current lack of understanding of the underlying fundamental growth mechanisms for WS₂ and related transition metal dichalcogenides. Au effectively promotes the sulfidation of W with simple organosulfides, enabling WS₂ growth with low DMS pressure (<1 mbar) and a suppression of carbon contamination of as-grown WS₂, which to date has been a major challenge with this precursor chemistry. Full WS₂ coverage can be achieved by one exposure cycle of 10 minutes at 700 °C. We discuss our findings in the wider context of previous literature on heterogeneous catalysis, 2D crystal growth, and overlapping process technologies such as atomic layer deposition (ALD) and direct metal conversion, linking to future integrated manufacturing processes for transition metal dichalcogenide layers.

Received 7th September 2020,

Accepted 27th October 2020

DOI: 10.1039/d0nr06459a

rsc.li/nanoscale

Introduction

Tungsten disulfide (WS₂) is a prominent material of the transition metal dichalcogenide (TMDC) family, with a characteristic layered structure of hexagonally packed metal atoms sandwiched between two layers of chalcogen atoms. Monolayer WS₂ exhibits a wide direct bandgap ($E_g \approx 2$ eV), strong spin-orbit coupling and bright room-temperature photoluminescence (PL).^{1–4} As a prototypical 2D semiconductor, WS₂ has raised promise in applications ranging from (opto-) electronics to spintronics and sensors.^{1–4} These emergent applications drive the need for scalable growth of atomically thin, highly crystalline “electronic-grade” 2D layers/films,⁵ which is distinct from

the historic focus on TMDC bulk crystal growth,⁶ and from classic TMDC application areas such as lubricants or catalysis.⁷ A large body of recent literature highlights the progress in such “electronic-grade” TMDC layer growth.⁵ However, the vast parameter space and increased complexity in structure and possible mechanisms, when compared to graphene for instance, leaves the understanding of even the basic processes of TMDC layer growth still severely limited.

The currently most prevalent TMDC growth method employs powder vaporisation, typically based on the sublimation of solid precursors in a hot wall reactor, and has demonstrated large monolayer TMDC crystal domains (>100 μm) on inert substrates like SiO₂/Si,⁸ and sapphire,⁹ as well as on metals such Ni–Ga alloys¹⁰ and Au.^{11,12} For the latter, growth has been referred to as catalytic,¹¹ analogous to graphene and nanowire growth.^{13,14} However, the growth atmosphere is difficult to accurately control and modulate, which restricts uniformity and scalability as well as makes such powder based techniques too complex, as model systems, to advance the required fundamental understanding of crystal growth. Driven by the need for low-cost, high through-put and industrial compatibility, metal–organic chemical vapour deposition (MOCVD) and related atomic layer deposition (ALD) type tech-

^aElectrical Engineering Division, Department of Engineering, University of Cambridge, UK. E-mail: sh315@cam.ac.uk

^bDepartment of Materials, University of Oxford, Parks Road, Oxford OX1 3PH, UK

^cDiamond Light Source Ltd, Harwell Science and Innovation Campus, Didcot OX11 0DE, UK

^dNational Physical Laboratory, Hampton Rd, Teddington, Middlesex, TW11 0LW, UK

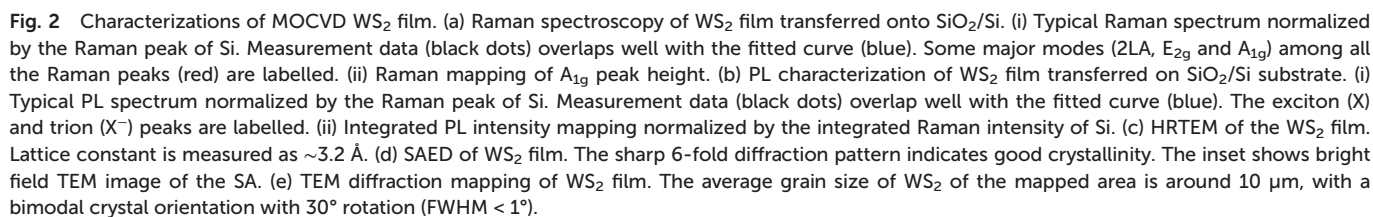
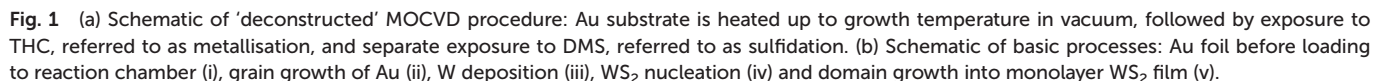
†Electronic supplementary information (ESI) available: Further sample characterisation, including ToF-SIMS, electrical device data, SEM and XPS. See DOI: 10.1039/d0nr06459a

‡Contributed equally.



We here focus on a “deconstructed” MOCVD process for WS_2 , based on a simple sequential exposure pattern of low cost, low toxicity precursors, namely tungsten hexacarbonyl [THC; $\text{W}(\text{CO})_6$] and dimethyl sulfide [DMS; $\text{S}(\text{CH}_3)_2$]. This sequential exposure pattern, combined with cold wall reactor use, minimises precursor pre-reactions and promotes a substrate surface bound reaction path. It also enables us to explore the entire WS_2 growth process by *operando* X-ray photoelectron spectroscopy (XPS) in order to develop a more detailed understanding. We employ this model system to explore the effects of using a metal substrate for such MOCVD process, specifically Au. Au forms no stable compounds with either W or S in bulk form, W or S solubilities in solid Au are not significant,³⁷ and Au(111) has been widely used in surface science studies of TMDC growth.^{31,32} Sulfidation with organosulfides like DMS or dimethyl disulfide (DMDS), compared to H_2S , is known to result in catalysts with a higher intrinsic HDS reactivity, whereby the effective chemical potential of sulfur is lowest for DMS,³⁸ and found to affect the size and morphology

The MOCVD process is ‘deconstructed’ into 2 steps with sequential exposure of metal and chalcogenide precursors as schematically highlighted in Fig. 1. Poly-crystalline Au foil (25 μm thick; Alfa Aesar) is used as the growth substrate and is annealed and plasma cleaned prior to being loaded into the MOCVD reaction chamber (Fig. 1(b, i)). The grain size of Au is around 100 μm . For *ex situ* experiments, a custom-built cold wall reactor (base pressure of 2.5×10^{-6} mbar) is used with remote sample heating *via* an IR laser (see Methods). Laser heating enables a low thermal mass for fast ramping and quenching, while at the same time minimizes cross-contamination. For *operando* XPS we employed an environmental reaction chamber with resistive heating (see Methods). The sample is initially held in vacuum at growth temperature to desorb surface contaminants and stabilize growth conditions (Fig. 1(b, ii)), followed by a low pressure (5×10^{-6} mbar) THC exposure, which we refer to as “metallization” (Fig. 1(b, iii)). THC is a well-studied precursor for W film deposition that readily decomposes at 700 $^{\circ}\text{C}$ particularly on metallic surfaces.⁴³ The second-growth step is a DMS exposure, which we refer to as “sulfidation” (Fig. 1(b, iv)). For a sub-set of experiments the sample was quenched to below 250 $^{\circ}\text{C}$ within 30 s after metallisation, before being heated back to 700 $^{\circ}\text{C}$ for the sulfidation, in order to completely decouple the process steps. However, we find that such quenching does not affect the growth outcome for the given set-ups and probed parameter space in comparison to isothermal processing at 700 $^{\circ}\text{C}$, as indicated in Fig. 1. We find the sulfidation will happen fast enough to result in continuous WS_2 films with DMS pressures as low as 0.1 mbar (Fig. 2). This parameter choice was thus adopted for the *operando* XPS experiments (Fig. 3). A full characterization of WS_2 grown with DMS pressures varied between 0.03 and 1 mbar is presented in Fig. 5 with focus on the carbon contamination.



laser excitation for WS₂ transferred onto SiO₂.^{44–46} Fig. 2(a, ii) shows a map of A_{1g} peak height over 108 μm × 154 μm area, which confirms the continuity of the as-transferred WS₂ layer. The monolayer nature of as-grown WS₂ is further confirmed by the strong PL peak with an exciton energy of ~2.02 eV (Fig. 2(b, i)). Fig. 2(b, ii) shows a map of normalized integrated PL intensity over the same area as the Raman mapping in Fig. 2(a, ii). Despite some fluctuations, the PL intensity of WS₂ film is always orders of magnitudes stronger than the Si Raman signal (also stronger than the WS₂ Raman signal), consistent

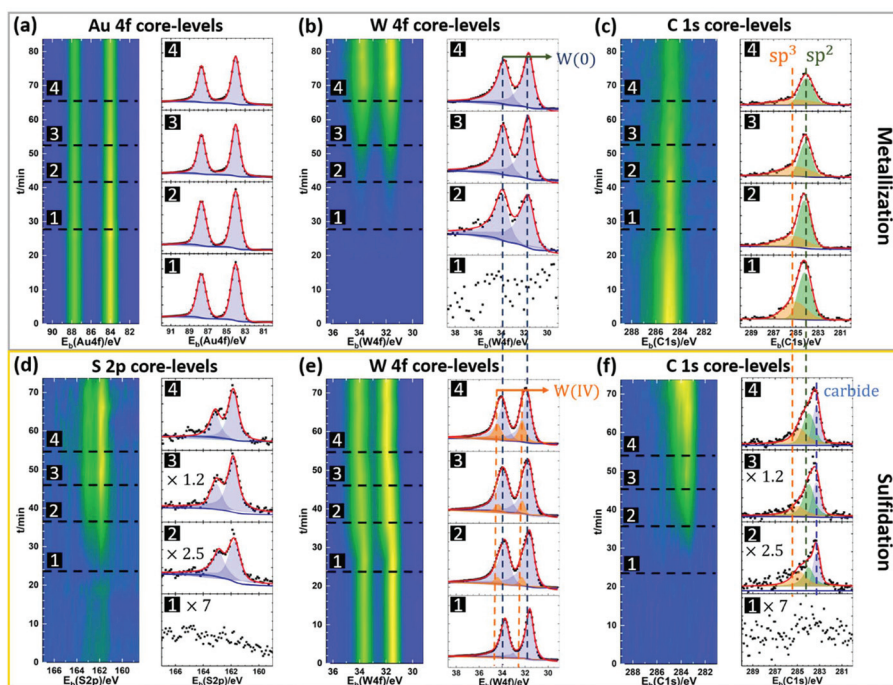


Fig. 3 Operando XPS of the MOCVD process. (a)–(c) Time-resolved Au 4f, W 4f and C 1s core-level spectra, respectively, during metallization step. (d)–(f) Time-resolved S 2p, W 4f and C 1s core-level spectra, respectively, during the sulfidation step. From (a) to (f), the XPS intensity map over reaction time is presented on the left, while the selected spectra of each element showing different reaction stages are presented on the right.

with the monolayer character of the WS_2 and the absence of WS_2 multi-layer regions.³ Similar to previous reports on CVD/MOCVD WS_2 , a significant trion peak around 1.98 eV is detectable.⁴⁷

Fig. 2(c)–(e) show high resolution transmission electron microscope (HRTEM) images and diffraction mapping results for a transferred WS_2 film. The representative HRTEM image in Fig. 2(c) highlights the crystallinity of the WS_2 , confirming a hexagonal lattice structure. The lattice constant is approximately 3.18 Å, which is consistent with both theory,^{48,49} and previously reported measurement results.^{50,51} The selected-area electron diffraction (SAED) analysis in Fig. 2(d) shows a matching clear hexagonal diffraction pattern with sharp spots. In order to determine the crystal orientation over a reasonably large area, over 200 diffraction patterns across a $40\ \mu\text{m} \times 40\ \mu\text{m}$ WS_2 film area were taken to construct the map shown in Fig. 2(e). We find two dominating crystal orientations rotated by $30^\circ \pm 1^\circ$ as highlighted by the bimodal distribution (Fig. 2(e)). Although the influence of crystal orientation of the Au to the crystal orientation of WS_2 is not our focus in this report, we are aware of the possible heterogeneity in WS_2 arising from the poly-crystallinity of the Au substrate. The data indicates, however, an average WS_2 grain size of the order of 10 μm , which compares favourably to previous literature on MOCVD TMDC materials on non-catalytic substrates with typical domain sizes on the order of a few micrometres.²⁰ The representative transfer curve of a two-terminal WS_2 field effect transistor (FET) device structure is shown in Fig. S3 in ESI† with a positive light response. The MOCVD WS_2 shows n-type

behaviour with a field-effect mobility of approximately $0.5\ \text{cm}^2\ \text{V}^{-1}\ \text{s}^{-1}$, which is comparable to previously reported values.^{11,52}

In this paper, we focus on providing insight into the reactions during the ‘deconstructed’ MOCVD process and identifying the key parameters for WS_2 crystal growth control. Fig. 3 shows time-resolved *operando* XPS of the metallization and sulfidation steps. Fig. 3(a)–(c) show the Au 4f, W 4f and C 1s core level data during the metallization step. In Fig. 3(a), the Au 4f_{7/2} core level energy is fixed to 84.0 eV allowing calibration of the other spectra. The peak position of the Au 4f_{5/2} was 87.7 eV, consistent with a spin-orbit splitting of 3.7 eV.⁵³ During the metallization process, the intensities of the Au 4f peaks decrease over time, while the intensities of W 4f peaks increase, (Fig. 3(a) and (b)) indicating the deposition of W onto the Au surface. The binding energies (BEs) of the W 4f doublet are measured at $\sim 31.5\ \text{eV}$ and $\sim 33.7\ \text{eV}$ for the W 4f_{7/2} and W 4f_{5/2}, respectively. The long-tail character of the W doublet peaks are fitted well by Doniach–Šunjić (DS) line-shapes, which confirms that the deposited tungsten is metallic.⁵⁴ We note that a W 5p_{3/2} component is expected around 5.5 eV to 6 eV above the W 4f_{7/2}, but is of insufficient intensity to be resolved above the tail. To rule out the formation of tungsten carbide, the C 1s core-level is measured during the metallization process. The broad peaks at 284.2 eV (assigned to sp² carbon) and at 285.3 eV (assigned to sp³ carbon) can be detected prior to exposure as shown in Fig. 3(c), consistent with amorphous carbon (a-C) species.⁵⁵ The C 1s peak associated with tungsten carbide is expected to have a distinctly lower BE ($\sim 283.3\ \text{eV}$) than what is measured during the metal-



Fig. 3(d)–(f) shows the S 2p, W 4f and C 1s core level spectra during the sulfidation step. The formation of WS₂ is marked by an increase in S 2p doublet peak intensity with the BEs of 161.8 eV (S 2p_{3/2}) and 163.0 eV (S 2p_{1/2}), respectively. These BEs agree with previously reported values for WS₂.⁵⁷ The conversion of W to WS₂ is also marked by the shift and broadening of the W 4f lines during sulfidation, as shown in Fig. 3(e) and Fig. S5 in ESI.† W core level signatures from both metallic tungsten and WS₂ are observable during sulfidation. The W 4f peaks for WS₂ are measured at 32.2 eV for W 4f_{7/2} and 34.4 eV for W 4f_{5/2}, with their intensities increasing during DMS exposure, as shown in Fig. 3(e). It is interesting to note that only a fraction of W transforms into WS₂ even for extended DMS exposure (Fig. 3(e)). This indicates the self-limiting nature of the tungsten sulfidation reaction on the surface of Au. Since the W 4f peaks for metallic tungsten overlap strongly with those for carbide,⁵³ we do not separate them when fitting the W 4f signals. The metal carbide and other carbon contamination in as-grown WS₂ is monitored by the C 1s signal (Fig. 3(f)), which clearly increases during sulfidation. We notice a significant C 1s core level signal around 283.3 eV, in addition to the two peaks attributed to a-C in Fig. 3(c). We assign this to tungsten carbide with a distinctively lower BE. This indicates the formation of metal carbide as a side reaction and confirms DMS as the source of carbon contamination for the WS₂ MOCVD process studied here. Although the sulfidation of W is self-limiting, the deposition of a-C contamination proceeds with ongoing DMS exposure (ESI, Fig. S4†).

To further study the role of the Au surface in the MOCVD process, we compare the growth result of WS₂ on bare Au to that on monolayer hexagonal boron nitride (hBN) covered Au

(Fig. 4). The motivation thereby is for the hBN to suppress direct gas precursor contact with the Au surface. hBN has been used as growth substrate in previous reports and is known remain intact after the MOCVD reaction.⁵⁸ We also expect hBN to affect adatom mobilities. Monolayer hBN was grown by CVD on Pt and transferred onto the Au using PMMA.⁵⁹ Post-growth ToF-SIMS imaging is used to map the growth results, as shown in Fig. 4(b). Fig. 4(b, i) shows a $500\text{ }\mu\text{m} \times 500\text{ }\mu\text{m}$ map of the detected B^+ ion species, that act as a fingerprint for the presence of the hBN film. The B^+ map indicates continuous hBN coverage on Au after WS_2 growth and confirms that the hBN film remains intact throughout the MOCVD process. Fig. 4(b, ii) shows a map of the detected WS_3^- ion species, used to fingerprint the presence of WS_2 . We find that a WS_2 film only forms on the Au surface without hBN coverage. The unreacted W will be oxidized in air at the post-growth stage, so tracking the location of the WO_3^- ion species enables us to separate the signals of unreacted W and WS_2 , as shown in Fig. 4(b, iii). W is found on both the hBN covered and uncovered Au surface. This is consistent with the high chemical reactivity of the THC precursor and its ready thermal decomposition at the metallisation temperature.⁴³ The more sporadic W coverage on the hBN can be due to increased desorption and/or increased W adatom mobility. To rule out the influence of polymer residues on the hBN to the decomposition of DMS, Fig. 2(b, iv) presents a map of the detected C_2^- ion species on the surface as a fingerprint for such carbon contamination. No difference in the average carbon level between the hBN covered and uncovered Au surface is observed. We thus rule out polymer residuals as a cause of the different WS_2 growth behaviour on Au and hBN covered Au. Moreover, this result also highlights that although the sulfidation rate is promoted by Au, side reactions such as the formation of carbides (see Fig. 3f) are similar on the different substrates.

Fig. 5 shows Raman spectroscopy and ToF-SIMS data, highlighting the influence of DMS partial pressures during sulfidation on the carbon contamination of as-grown WS_2 on Au.

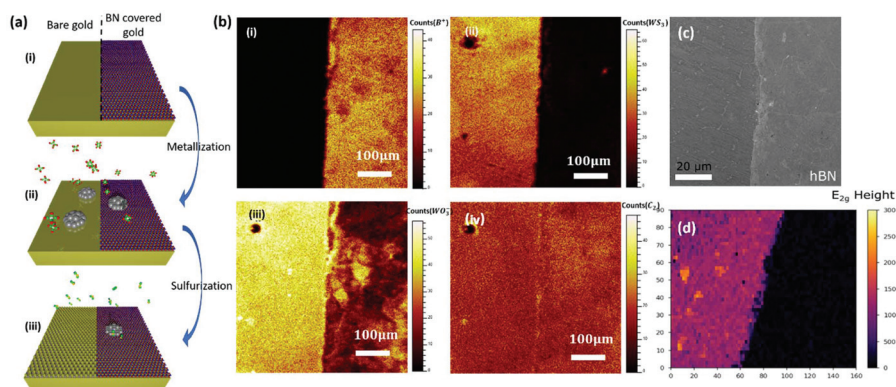


Fig. 4 WS_2 growth on Au partially covered by monolayer hBN. (a) Schematic of sample (i) and MOCVD procedure with metallisation (ii) and sulfidation (iii). (b) Select ToF-SIMS surface images of the sample after complete MOCVD process: (i) B^+ image highlighting hBN coverage; (ii) WS_3^- image highlighting WS_2 coverage; (iii) WO_3^- image to characterize W coverage; (iv) C_2^- image to characterize residual carbon. (c) SEM image of sample. No WS_2 is found to grow on hBN covered Au. (d) Raman intensity map of sample. E_{2g} height is mapped near the edge of hBN after MOCVD of WS_2 .

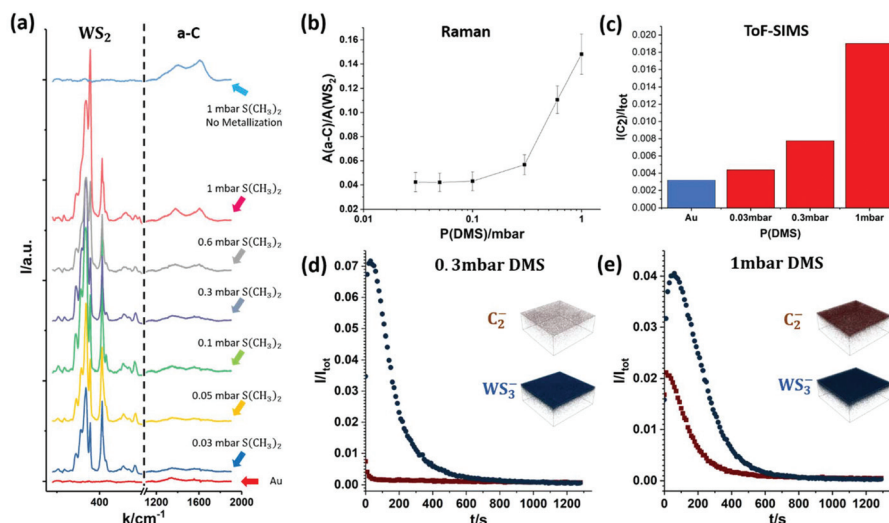


Fig. 5 Carbon contamination introduced during sulfidation step: (a) Raman spectra of samples grown at different DMS pressures. For reference, the Raman spectra of as-annealed Au foil (red curve, bottom) and Au foil with only sulfidation at 1 mbar (light blue curve, top), but without metallization, are also included. (b) Integrated Raman peak intensity ratio between amorphous carbon (a-C) and WS_2 vs. DMS pressure during sulfidation. The error bar is 5 times of the variation in each measurement. (c) Normalized ToF-SIMS C_2^- ion intensity vs. DMS pressure during sulfidation. For reference, measurement on as-annealed Au foil is also included. (d) and (e) ToF-SIMS depth profile and $150\ \mu\text{m} \times 150\ \mu\text{m}$ 3D depth profile images for C_2^- and WS_3^- ions for a WS_2 monolayer grown on Au foil comparing low (0.3 mbar, (d)) and high (1 mbar, (e)) DMS pressures during sulfidation. Both carbon and WS_2 uniformly distribute over the $150\ \mu\text{m} \times 150\ \mu\text{m}$ region of measurement.

Fig. 5(a) plots the intensity of characteristic Raman peaks for WS_2 and a-C for DMS pressures from 0.03 mbar to 1 mbar during sulfidation. For comparison, Fig. 5(a) also shows the spectra for plain, annealed Au foil (red curve, bottom) and Au foil that has undergone only sulfidation (without prior metallization) at 1 mbar (light blue curve, top). The data shows that the a-C Raman peak intensities increase with increasing partial pressures of DMS. Furthermore, Fig. 5(b) plots the integrated Raman peak intensity of a-C (from $1100\ \text{cm}^{-1}$ to $1900\ \text{cm}^{-1}$) normalized by the integrated peak intensity of WS_2 (from $250\ \text{cm}^{-1}$ to $500\ \text{cm}^{-1}$). This highlights that the carbon contamination increases greatly past 0.3 mbar DMS pressure during sulfidation, which is consistent with previous literature regarding the strong contamination from DMS in MOCVD TMDC growth in the millibar pressure range.²⁰

In order to further confirm the correlation between DMS partial pressure and carbon contamination, we employ ToF-SIMS depth profiling with a very gentle sputter rate to measure the chemical environment of monolayer WS_2 on the Au surface. The depth profiles of carbon and WS_2 are summarized in Fig. 5(c)–(e). Among the many carbon species detectable due to the complex decomposition of DMS, we find the C_2^- ion signal to be the most intense, and hence employ here the C_2^- ion signal as an indicator of carbon contamination. In Fig. 5(c) the C_2^- ion intensity for an as-annealed Au foil is additionally added to reference for the level of absorbed carbon contamination due to sample transfer in air. The ToF-SIMS data (Fig. 5(c)) confirms the trend seen in the Raman spectroscopy data (Fig. 5(b)) with the carbon concentration increasing with DMS partial pressure. Fig. 5(d) and (e) also show representative ToF-SIMS 3D depth profile images of

fully grown WS_2 monolayers on Au foil comparing low (0.3 mbar, Fig. 5(d)) and high (1 mbar, Fig. 5(e)) DMS pressures during sulfidation. The depth profiles are normalized with respect to total ion count to allow direct comparison (see Methods). The 3D ion image insets show that for both samples the C_2^- and WS_3^- ion intensities are uniform laterally across the measured $150\ \mu\text{m} \times 150\ \mu\text{m}$ area. However, the C_2^- ion intensity on the Au surface is significantly higher for the sample sulfidized in 1 mbar DMS. Regarding the depth dependence, the ToF-SIMS depth profiles show that for the sample grown with a low partial pressure of DMS the carbon contamination only appears on the very surface and quickly diminishes when probing further into the WS_2 layer and Au (Fig. 5(d)). In contrast, for a high partial pressure of DMS, a much higher C_2^- ion intensity is detected on and away from the surface, indicating a heavier carbon contamination of the as-grown WS_2 . This is further evidenced by the $2\ \text{mm} \times 2\ \text{mm}$ surface images of the samples shown in Fig. S2 in ESI,[†] confirming an elevated carbon signal on the surface of the sample with high (1 mbar) DMS partial pressure.

Our simple, “deconstructed” MOCVD process allows a ‘first-order’ growth model to be developed that provides a framework for rational future process design and sets the foundation for exploring more detailed effects such as the influence of Au surface orientation. Our *operando* XPS data shows that the THC exposure leads to metallic W deposition on the Au surface. Our ToF-SIMS shows negligible levels of W and S in the post-growth Au bulk (see ESI, Fig. S1 and S2[†]), consistent with reported bulk phase diagrams.³⁷ Monolayer WS_2 growth occurs at isothermal conditions, with no further growth or precipitation of W or S during cooling (Fig. 3). Bulk



dissolution effects are not significant to such WS₂ growth. Extended THC exposure, *i.e.* more W deposition, does not lead to multi-layer WS₂ growth. Rather, we observe an increasing number of particles (see ESI, Fig. S6†) in addition to the WS₂ monolayer. Previous STM work on epitaxial MoS₂ nucleation on Au(111) highlights the presence of amorphous Mo clusters as a result of insufficient sulfidation.³² In analogy we propose excess W as the source of the observed particles here. This is consistent with the SIMS mapping in Fig. 4 showing W clusters on hBN covered Au. Since W can be detected on both hBN covered Au and bare Au, we determine that the THC decomposition is not surface selective in our reaction conditions. The W clustering indicates a reasonably high W surface mobility, which is required to achieve large WS₂ crystal domain sizes. We observe no W sulfidation on top of the hBN (Fig. 4). Further, we note that as the tungsten thickness is increased the sulfidation to WS₂ at the same conditions becomes less complete, and for W foil (~25 μm), we can detect no 2D WS₂ by Raman after sulfidation. This clearly highlights the role of the exposed Au surface in promoting sulfidation of W by DMS to form WS₂. In contrast to H₂S, which has been shown to promote metal sulfidation on top of an existing TMDC layer, thereby leading to multi-layer TMDC growth,³² DMS presents a lower effective sulfur chemical potential, consistent with the lower TMDC growth rates that have been observed compared to when H₂S is used.³⁸ For our sulfidation process Au allows a significant lowering of the partial pressure of the DMS while still enabling high WS₂ growth rates so that full coverage can be achieved with <10 min sulfidation cycles. Importantly, WS₂ growth in our process is “self-limited” to monolayer thickness. This can be rationalised with the known high affinity of Au for organosulfide adsorption leading to selectively enhanced concentrations on the Au surface.⁴² In turn, less efficient chemisorption and high precursor desorption can be expected for inert surfaces like hBN. Thus, with the lower effective sulfur chemical potential of DMS, the supersaturation required for WS₂ nucleation is only satisfied on the Au surface in our reaction conditions. Once a layer of WS₂ grows and covers the Au, it prevents the DMS molecules from reaching the Au, similar to the hBN layer in Fig. 4. This leads to the observed self-limiting WS₂ growth behaviour.

Thermal decomposition of DMS is reported to be slow and incomplete at our reaction temperature of 700 °C.^{60,61} The relatively fast WS₂ growth time that we observe is indicative of a clear enhancing effect of the metallic Au surface for the sulfidation with DMS. This is consistent with the known strong chemisorption of organosulfides on Au and their favourable dissociation on Au reported in heterogeneous catalysis literature.^{40–42} There are a range of possible competing reactions including W carbide formation.⁶² Our *operando* XPS data highlights that although the sulfidation of W is self-limiting, the deposition of a-C contamination and formation of tungsten carbide proceeds with ongoing DMS exposure (Fig. 3). This is consistent with excess W being present on top of the formed WS₂ layer, similar to excess Mo clusters reported in previous STM work on top of formed MoS₂ layers on Au.³² It

appears that without direct contact to Au, the DMS exposure of excess W results in a different reaction pathway dominated by carbide/surface carbon formation. The result of DMS exposure of W clusters will further depend on their support, as indicated by the different behaviour on hBN (Fig. 4).

Conclusions

We use a deconstructed MOCVD model process to understand the detailed chemical reaction during MOCVD process and discover the significant enhancing role of Au on the sulfidation step, which results WS₂ monolayer growth with a simple organosulfide like DMS. This opens the possibility of using less-toxic precursors for MOCVD and ALD-type reactions, while achieving low carbon contamination and fast growth times. The much lower chalcogen precursor pressure not only yields self-limiting monolayer WS₂ growth but also makes the overall process much more efficient and gives wider compatibility with standard growth reactors. The reaction scheme also opens future *operando* process characterisation opportunities, to further progress the understanding of the underlying mechanisms. *Operando* characterisation has been crucial to advancing the understanding and thus control of graphene and hBN film growth,¹³ and we expect our results and the growth model presented here to form the basis for more detailed understanding of TMDC MOCVD. In analogy to catalytic graphene growth on Pt, this will include metal surface orientation dependent growth kinetics, and links to the challenge of cost-efficient and scalable metal substrate preparation.^{63,66} While we here focus on Au, which requires subsequent WS₂ transfer for typical opto-electronic device applications, our findings also motivate further studies on catalytic enhancement of dielectric support films, which would allow direct, transfer-free device integration. In contrast, for electro-chemical applications TMDC layers grown directly on Au can serve as powerful model system for new approaches to catalyst design.

Methods

‘Deconstructed’ MOCVD growth of WS₂ on Au

25 μm Au foils with 99.985% purity from Alfa Aesar were used as the growth substrates. All as-received Au substrates were annealed for 6 hours at 1025 °C under total pressure of 800 mbar with H₂ : Ar = 1 : 9. Right before the growth, samples were treated by oxygen RIE (150 mTorr, 50 W, 5 min) to remove surface carbon contamination. All *ex situ* MOCVD growth was carried out in a cold-wall low pressure MOCVD furnace. An 808 nm continuous wave (CW) IR laser was used for sample heating. Sample temperature during growth was monitored by 1.6 μm IR pyrometer assuming transmission 0.9 and emissivity 0.2. The temperature measurement error was estimated as ~50 °C. In all experiments, the samples were heated to 700 °C under base pressure better than 3 × 10^{−6} mbar for 15 min to



anneal and stabilize the system. After the annealing, $W(CO)_6$ (99.9%+ purity from Strem Chemicals) was sublimed at 120 °C and fed into the system as the W precursor during metallization. The partial pressure of $W(CO)_6$ was controlled by leak-valve, which allow a pressure control precision better than 5×10^{-7} mbar. During the metallization, 5×10^{-6} mbar $W(CO)_6$ was introduced to the chamber and exposed to Au foil at 700 °C for 5 min. After this, 5.5×10^{-3} mbar Ar is introduced to stabilize the base pressure when $S(CH_3)_2$ (99%+ purity from Sigma Aldrich) was fed into the system as S precursor during sulfidation. The partial pressure of $S(CH_3)_2$ was also controlled by a leak-valve. $S(CH_3)_2$ with controlled partial pressure ranging from 0.01 mbar to 1 mbar was introduced for the sulfidation of different samples to compare its influence on WS_2 produced. After sulfidation, the sample is cooled down rapidly for further characterization.

CVD/transfer of hBN

hBN was grown on 25 μ m thick platinum (Pt) foils (99.99%, Alfa Aesar) on a 0.5 mm tantalum (Ta) foil support as previously reported.⁵⁹ Prior to loading, the Pt foils were cleaned by sonication in acetone followed by iso-propanol and dried with a nitrogen gun. The growth recipe consisted of heating the sample in base pressure $\sim 2 \times 10^{-6}$ mbar to 1000 °C then annealing at temperature for 5 minutes. Subsequently, 1×10^{-5} mbar partial pressure of borazine (>97%, Fluorochem) was dosed into the chamber *via* a manually operated leak valve to initiate isothermal growth for 5 minutes. A continuous monolayer BN is produced on Pt by this method. The sample was rapidly cooled under borazine atmosphere.

Electrical delamination, or 'bubbling', transfer of hBN is used to peel BN off from Pt.⁶⁴ PMMA (A4, 950k) was spun on the as grown hBN on Pt at 3000 rpm for 45 s as the scaffold layer. PMMA/BN is then peeled off from the Pt by hydrogen bubbling generated by the electrolysis of water in 0.2 M Na (OH) (aq.). The film is then rinsed and fished up by a piece of Au foil to cover half of the surface. After drying overnight, the Au piece with semi-coverage of PMMA/BN is heated to 180 °C for 30 min to soften the PMMA then soaked in acetone to remove the PMMA scaffold.

Transfer of WS_2 on Au by wet etching

PMMA (A4, 950k) was spun on the as grown WS_2 on gold at 3000 rpm for 45 s. The sample is then baked at 120 °C for 3 min to evaporate the solvent of polymer. WS_2 covering the backside of gold is removed by 50 W, 20 s reactive ion etching (RIE) in 150 mTorr CF_4 . After the RIE, gold is etched by KI/I_2 based gold etchant (Sigma-Aldrich) within 4 hours. The sample is then scooped out and rinsed in DI water for several times before being fished out by the target substrate and dried.

Raman/PL

Both Raman and PL spectra of samples are taken by a Renishaw inVia Raman system. The excitation laser is 20 mW, 532 nm. Single spot Raman is measured with 1% laser power 2 s exposure and accumulated 6 times. For Raman mapping,

10% laser power, 0.1 s exposure is used for each spot with a step size of 2 μ m in both x and y direction. Single spot PL is measured by 0.1% laser power 1 s exposure and accumulated 2 times. For PL mapping, 1% laser power, 0.25 s exposure is used for each spot with a step size of 2 μ m in both x and y direction. The sample is kept in the same orientation during all spectroscopy measurements to make sure that the Raman intensity of the silicon reference peak is unchanged.

For the Raman data taken from WS_2 on Au, an Au baseline is taken separately and subtracted from all measured spectra. The integrated intensity for WS_2 is calculated from the peak intensity from 250 cm^{-1} to 500 cm^{-1} . The integrated intensity for a-C is calculated from the peak intensity from 1100 cm^{-1} to 1900 cm^{-1} .

TEM

Quanti-foil TEM grid is used as the support for WS_2 in the associated TEM studies. After transfer of the PMMA/ WS_2 onto the TEM grid, the sample is dried overnight then baked at 150 °C for 30 min to soften the polymer and increase the adherence of the WS_2 to the grid. The PMMA scaffold layer is then removed by dissolving in acetone. Tecnai Osiris TEM is used for imaging and diffraction. All measurement is taken under 80 keV acceleration voltage. For diffraction mapping, selected-area electron diffraction (SAED) is taken over a grid of spots across the large area being mapped. Crystal orientation of the sample is then constructed from relative rotation between the SAEDs.

ToF-SIMS

Ex situ ToF-SIMS measurement were performed using a ToF-SIMS IV instrument (ION-TOF GmbH, Germany) at a base pressure better than 5×10^{-9} mbar. 25 keV Bi_3^+ ions from the liquid metal ion gun (LMIG) are used for imaging. The LMIG spot size is less than 5 μ m in spectroscopy mode and is operated at a current of 0.1 pA. The surface maps (*i.e.* Fig. 4(b)) were acquired directly by randomly rastering the Bi_3^+ ion beam over the surface of the sample in an area of 500 μ m $\times$ 500 μ m in both positive and negative ion mode. For larger area maps, successive 500 μ m $\times$ 500 μ m images are stitched together to create the larger image. 2D depth profiles and 3D depth profile images are acquired by cyclically analysing a 150 μ m $\times$ 150 μ m area (with 256 $\times$ 256 pixel density and a mass spectra taken at each pixel) from the centre of a 400 μ m $\times$ 400 μ m sputtered region during the course of depth profiling to mitigate crater edge effects on the generated spectra. These cyclically analysed images are then combined to create a 3D image and the 2D profile. For sputtering cycles, either 10 keV Cs^+ ions (100 μ s cycle time) with an ion current of 30 nA for bulk characterisation, or 10 keV Ar_{2700}^+ (200 μ s cycle time) with an ion current of 0.36 nA from a GCIB for near surface region characterisation, were used. All ion beams are orientated at 45° to the sample surface. No charge compensation was used during these measurements. Data processing was carried out using Surface Lab (v.6.8.99996) software, by selecting relevant



peaks in the ToF-SIMS spectra and monitoring their change in intensity over the course of the sputter profiling.

XPS

Operando XPS measurements were performed at beamline B07-C of the Diamond Light Source (DLS), United Kingdom.⁶⁵ The environmental reaction chamber used in this study, or the 'T-cup', has a small (volume ~ 0.7 L) that allows sample temperature control between room temperature and ~ 1000 °C (via a button heater; HeatWave Labs) and local pressures between 10^{-5} mbar and 30 mbar. The sample cell is attached to a differentially-pumped hemispherical electron analyser (SPECS Phoibos 150 NAP) and a differentially pumped beamline interface which enables window-less exposure to synchrotron radiation in the photon energy range 170–2800 eV. Here, a photon energy of 700 eV was used for all measurements. The beamline exit slits were opened to 800 μm in the non-dispersive direction, and 100 μm in the dispersive direction for XPS, which results in a spot size around $75 \mu\text{m} \times 200 \mu\text{m}$. The energy resolution of the setup is ~ 0.5 eV for the energies used herein, as determined from the width of the Gaussian component of Voigt functions fitted to Au 4f spectra of gold films. The base pressure is $\sim 8 \times 10^{-7}$ mbar before heating and $\sim 4 \times 10^{-6}$ mbar during heating. All core level spectra were acquired with a pass energy of 20 eV and an energy step size of 0.1 eV.

The BE scale for each spectrum was referenced to simultaneously measured Au 4f_{7/2} core levels, setting the peak position to 84.0 eV. All fittings were performed by using a Shirley background to model inelastically scattered electrons and applying either a Doniach–Šunjić (DS) line-shapes for metallic species, or a Gaussian–Lorentzian (GL) line-shapes for non-metallic species. We do not set artificial constraints on the FWHM of peaks during fitting. During the sulfidation process, we notice that the signal intensity is unstable due to the introduction of DMS. To compare the data recorded at different times, all peaks recorded during the sulfidation process were normalized by the W 4f peak intensity.

Conflicts of interest

There are no conflicts of interest to declare.

Acknowledgements

We acknowledge funding from EPSRC (EP/T001038/1, EP/P005152/1). V.-P. V.-R. acknowledges EPSRC Doctoral Training Award (EP/M508007/1) and support from NPL. K. N., R. M. and A. E. D. acknowledge funding from the EPSRC Cambridge NanoDTC (Grant No. EP/G037221/1), C. S. from the Graphene CDT (Grant No. EP/L016087/1). B. B. and A. J. P. acknowledge funding from the U.K. Department of Business, Energy and Industrial Strategy (NPL Project Number 121452). J. A.-W. acknowledges the support of his Research Fellowship from Royal Commission for the Exhibition of 1851, and Royal

Society Dorothy Hodgkin Research Fellowship. Y. F. also thanks Prof. Wencai Ren for the helpful discussions on the effect of pre-annealing of gold to CVD WS₂. This work was carried out with the support of the Diamond Light Source, instrument B07-C (proposal SI-22123).

References

- Q. H. H. Wang, K. Kalantar-Zadeh, A. Kis, J. N. N. Coleman and M. S. S. Strano, *Electronics and optoelectronics of two-dimensional transition metal dichalcogenides*, Nature Publishing Group, 2012, vol. 7.
- X. Xu, W. Yao, D. Xiao and T. F. Heinz, *Nat. Phys.*, 2014, **10**, 343–350.
- K. F. Mak and J. Shan, *Nat. Photonics*, 2016, **10**, 216–226.
- J. Ping, Z. Fan, M. Sindoro, Y. Ying and H. Zhang, *Adv. Funct. Mater.*, 2017, **27**, 1605817.
- N. Briggs, S. Subramanian, Z. Lin, X. Li, X. Zhang, K. Zhang, K. Xiao, D. Geohegan, R. Wallace, L.-Q. Chen, M. Terrones, A. Ebrahimi, S. Das, J. Redwing, C. Hinkle, K. Momeni, A. van Duin, V. Crespi, S. Kar and J. A. Robinson, *2D Mater.*, 2019, **6**, 022001.
- Preparation and Crystal Growth of Materials with Layered Structures*, ed. R. M. A. Lieth, Springer Netherlands, Dordrecht, 1977.
- R. R. Chianelli, M. H. Siadati, M. P. De la Rosa, G. Berhault, J. P. Wilcoxon, R. Bearden and B. L. Abrams, *Catal. Rev.*, 2006, **48**, 1–41.
- Y. Rong, Y. Fan, A. Leen Koh, A. W. Robertson, K. He, S. Wang, H. Tan, R. Sinclair and J. H. Warner, *Nanoscale*, 2014, **6**, 12096–12103.
- Z.-Q. Xu, Y. Zhang, S. Lin, C. Zheng, Y. L. Zhong, X. Xia, Z. Li, P. J. Sophia, M. S. Fuhrer, Y.-B. Cheng and Q. Bao, *ACS Nano*, 2015, **9**, 6178–6187.
- L. Fu, Y. Sun, N. Wu, R. G. Mendes, L. Chen, Z. Xu, T. Zhang, M. H. Rummeli, B. Rellinghaus, D. Pohl, L. Zhuang and L. Fu, *ACS Nano*, 2016, **10**, 2063–2070.
- Y. Gao, Z. Liu, D. M. Sun, L. Huang, L. P. Ma, L. C. Yin, T. Ma, Z. Zhang, X. L. Ma, L. M. Peng, H. M. Cheng and W. Ren, *Nat. Commun.*, 2015, **6**, 1–10.
- S. J. Yun, S. H. Chae, H. Kim, J. H. C. Park, J. H. C. Park, G. H. Han, J. S. Lee, S. M. Kim, H. M. Oh, J. Seok, M. S. Jeong, K. K. Kim and Y. H. Lee, *ACS Nano*, 2015, **9**, 5510–5519.
- S. Hofmann, P. Braeuninger-Weimer and R. S. Weatherup, *J. Phys. Chem. Lett.*, 2015, **6**, 2714–2721.
- F. M. Ross, *Rep. Prog. Phys.*, 2010, **73**, 114501.
- D. Akinwande, C. Huyghebaert, C.-H. Wang, M. I. Serna, S. Goossens, L.-J. Li, H.-S. P. Wong and F. H. L. Koppens, *Nature*, 2019, **573**, 507–518.
- S. Cwik, D. Mitoraj, O. Mendoza Reyes, D. Rogalla, D. Peeters, J. Kim, H. M. Schütz, C. Bock, R. Beranek and A. Devi, *Adv. Mater. Interfaces*, 2018, **5**, 1800140.
- J. W. Chung, Z. R. Dai and F. S. Ohuchi, *J. Cryst. Growth*, 1998, **186**, 137–150.



- 18 K. Kang, S. Xie, L. Huang, Y. Han, P. Y. Huang, K. F. Mak, C.-J. J. Kim, D. Muller and J. Park, *Nature*, 2015, **520**, 656–660.
- 19 S. H. Choi, B. Stephen, J.-H. Park, J. S. Lee, S. M. Kim, W. Yang and K. K. Kim, *Sci. Rep.*, 2017, **7**, 1983.
- 20 T. H. Choudhury, H. Simchi, R. Boichot, M. Chubarov, S. E. Mohney and J. M. Redwing, *Cryst. Growth Des.*, 2018, **18**, 4357–4364.
- 21 J. J. Pyeon, S. H. Kim, D. S. Jeong, S.-H. Baek, C.-Y. Kang, J.-S. Kim and S. K. Kim, *Nanoscale*, 2016, **8**, 10792–10798.
- 22 Y. Kim, J.-G. Song, Y. J. Park, G. H. Ryu, S. J. Lee, J. S. Kim, P. J. Jeon, C. W. Lee, W. J. Woo, T. Choi, H. Jung, H.-B.-R. Lee, J.-M. Myoung, S. Im, Z. Lee, J.-H. Ahn, J. Park and H. Kim, *Sci. Rep.*, 2016, **6**, 18754.
- 23 B. Groven, M. Heyne, A. Nalin Mehta, H. Bender, T. Nuytten, J. Meersschaut, T. Conard, P. Verdonck, S. Van Elshocht, W. Vandervorst, S. De Gendt, M. Heyns, I. Radu, M. Caymax and A. Delabie, *Chem. Mater.*, 2017, **29**, 2927–2938.
- 24 W. Hao, C. Marichy and C. Journet, *2D Mater.*, 2018, **6**, 012001.
- 25 M. Mattinen, T. Hatanpää, T. Sarnet, K. Mizohata, K. Meinander, P. J. King, L. Khriachtchev, J. Räisänen, M. Ritala and M. Leskelä, *Adv. Mater. Interfaces*, 2017, **4**, 1700123.
- 26 C. Martella, P. Melloni, E. Cinquanta, E. Cianci, M. Alia, M. Longo, A. Lamperti, S. Vangelista, M. Fanciulli and A. Molle, *Adv. Electron. Mater.*, 2016, **2**, 1600330.
- 27 F. Maury, *J. Phys. IV*, 1995, **5**, C5-449–C5-463.
- 28 J. Park, N. Choudhary, J. Smith, G. Lee, M. Kim and W. Choi, *Appl. Phys. Lett.*, 2015, **106**, 012104.
- 29 Y. Zhan, Z. Liu, S. Najmaei, P. M. Ajayan and J. Lou, *Small*, 2012, **8**, 966–971.
- 30 L. K. Tan, B. Liu, J. H. Teng, S. Guo, H. Y. Low and K. P. Loh, *Nanoscale*, 2014, **6**, 10584–10588.
- 31 S. Helveg, J. V. Lauritsen, E. Lægsgaard, I. Stensgaard, J. K. Nørskov, B. S. Clausen, H. Topsøe and F. Besenbacher, *Phys. Rev. Lett.*, 2000, **84**, 951–954.
- 32 S. S. Grønberg, S. Ulstrup, M. Bianchi, M. Dendzik, C. E. Sanders, J. V. Lauritsen, P. Hofmann and J. A. Miwa, *Langmuir*, 2015, **31**, 9700–9706.
- 33 M. Dendzik, M. Michiardi, C. Sanders, M. Bianchi, J. A. Miwa, S. S. Grønberg, J. V. Lauritsen, A. Bruix, B. Hammer and P. Hofmann, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2015, **92**, 245442.
- 34 A. Koma, K. Sunouchi and T. Miyajima, *Microelectron. Eng.*, 1984, **2**, 129–136.
- 35 S. Tiefenbacher, H. Sehnert, C. Pettenkofer and W. Jaegermann, *Surf. Sci.*, 1994, **318**, 8–11.
- 36 Q. Ji, Y. Zhang, T. Gao, Y. Zhang, D. Ma, M. Liu, Y. Chen, X. Qiao, P.-H. Tan, M. Kan, J. Feng, Q. Sun and Z. Liu, *Nano Lett.*, 2013, **13**, 3870–3877.
- 37 B. Predel, Phase Equilibria, Crystallographic and Thermodynamic Data of Binary Alloys, in *Ac-Au – Au-Zr*, Springer, 1st edn, 1991.
- 38 H. G. Fächtbauer, A. K. Tuxen, Z. Li, H. Topsøe, J. V. Lauritsen and F. Besenbacher, *Top. Catal.*, 2014, **57**, 207–214.
- 39 A. Tuxen, H. Gøbel, B. Hinnemann, Z. Li, K. G. Knudsen, H. Topsøe, J. V. Lauritsen and F. Besenbacher, *J. Catal.*, 2011, **281**, 345–351.
- 40 Y. W. Yang and L. J. Fan, *Langmuir*, 2002, **18**, 1157–1164.
- 41 L. J. Cristina, G. Ruano, R. Salvarezza and J. Ferrón, *J. Phys. Chem. C*, 2017, **121**, 27894–27904.
- 42 R. Meyer, C. Lemire, S. K. Shaikhutdinov and H.-J. Freund, *Gold Bull.*, 2004, **37**, 72–124.
- 43 S. B. Knapp, *Kinetics of the Thermal Decomposition of Tungsten Hexacarbonyl*, Oregon State University, 1966.
- 44 K. M. McCreary, A. T. Hanbicki, S. Singh, R. K. Kawakami, G. G. Jernigan, M. Ishigami, A. Ng, T. H. Brintlinger, R. M. Stroud and B. T. Jonker, *Sci. Rep.*, 2016, **6**, 35154.
- 45 A. Berkdemir, H. R. Gutiérrez, A. R. Botello-Méndez, N. Perea-López, A. L. Elías, C.-I. Chia, B. Wang, V. H. Crespi, F. López-Urias, J.-C. Charlier, H. Terrones and M. Terrones, *Sci. Rep.*, 2013, **3**, 1755.
- 46 H. Zeng, G.-B. Liu, J. Dai, Y. Yan, B. Zhu, R. He, L. Xie, S. Xu, X. Chen, W. Yao and X. Cui, *Sci. Rep.*, 2013, **3**, 1608.
- 47 N. Peimyoo, J. Shang, C. Cong, X. Shen, X. Wu, E. K. L. Yeow and T. Yu, *ACS Nano*, 2013, **7**, 10985–10994.
- 48 A. Molina-Sánchez and L. Wirtz, *Phys. Rev. B*, 2011, **84**, 155413.
- 49 W. J. Schutte, J. L. De Boer and F. Jellinek, *J. Solid State Chem.*, 1987, **70**, 207–209.
- 50 Y. Fan, A. W. Robertson, Y. Zhou, Q. Chen, X. Zhang, N. D. Browning, H. Zheng, M. H. Rümmeli and J. H. Warner, *ACS Nano*, 2017, **11**, 9435–9444.
- 51 H. M. Hill, *Probing Transition Metal Dichalcogenide Monolayers and Heterostructures by Optical Spectroscopy and Scanning Tunneling Spectroscopy*, Columbia University, 2016.
- 52 Y. Zhang, Y. Zhang, Q. Ji, J. Ju, H. Yuan, J. Shi, T. Gao, D. Ma, M. Liu, Y. Chen, X. Song, H. Y. Hwang, Y. Cui and Z. Liu, *ACS Nano*, 2013, **7**, 8963–8971.
- 53 D. Briggs, *Handbook of X-ray Photoelectron Spectroscopy*, ed. C. D. Wanger, W. M. Riggs, L. E. Davis, J. F. Moulder and G. E. Muilenberg, Perkin-Elmer Corp., Physical Electronics Division, Eden Prairie, Minnesota, USA, 1979, 190 pp. \$195, 1981, vol. 3.
- 54 S. Doniach and M. Sunjic, *J. Phys. C: Solid State Phys.*, 1970, **3**, 285–291.
- 55 J. Díaz, G. Paolicelli, S. Ferrer and F. Comin, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 1996, **54**, 8064–8069.
- 56 A. Czyzniewski, *Thin Solid Films*, 2003, **433**, 180–185.
- 57 B. Späth, F. Kopnov, H. Cohen, A. Zak, A. Moshkovich, L. Rapoport, W. Jägermann and R. Tenne, *Phys. Status Solidi*, 2008, **245**, 1779–1784.
- 58 A. Yan, J. Velasco, S. Kahn, K. Watanabe, T. Taniguchi, F. Wang, M. F. Crommie and A. Zettl, *Nano Lett.*, 2015, **15**, 6324–6331.
- 59 R. Wang, D. G. Purdie, Y. Fan, F. C. Massabau, P. Braeuninger-weimer, O. J. Burton, R. Blume, R. Schloegl,



- A. Lombardo, R. S. Weatherup and S. Hofmann, *ACS Nano*, 2019, **13**, 2114–2126.
- 60 C. N. Koshelev, A. V. Mashkina and N. G. Kalinina, *React. Kinet. Catal. Lett.*, 1989, **39**, 367–372.
- 61 A. G. Vandeputte, M.-F. Reyniers and G. B. Marin, *J. Phys. Chem. A*, 2010, **114**, 10531–10549.
- 62 J. Luthin and C. Linsmeier, *Surf. Sci.*, 2000, **454–456**, 78–82.
- 63 R. S. Weatherup, A. J. Shahani, Z.-J. Wang, K. Mingard, A. J. Pollard, M.-G. Willinger, R. Schloegl, P. W. Voorhees and S. Hofmann, *Nano Lett.*, 2016, **16**, 6196–6206.
- 64 Y. Wang, Y. Zheng, X. Xu, E. Dubuisson, Q. Bao, J. Lu and K. P. Loh, *ACS Nano*, 2011, **5**, 9927–9933.
- 65 G. Held, F. Venturini, D. C. Grinter, P. Ferrer, R. Arrigo, L. Deacon, W. Quevedo Garzon, K. Roy, A. Large, C. Stephens, A. Watts, P. Larkin, M. Hand, H. Wang, L. Pratt, J. J. Mudd, T. Richardson, S. Patel, M. Hillman and S. Scott, *J. Synchrotron Radiat.*, 2020, **27**, 1153–1166.
- 66 O. J. Burton, F. C.-P. Massabuau, V.-P. Veigang-Radulescu, B. Brennan, A. J. Pollard and S. Hofmann, *ACS Nano*, 2020, **14**, 13593–13601.

